

Helping Customers Innovate, Improve & Grow

Table 1. Electrical Performance						
Parameter	Symbol	Min.	Тур	Max	Units	
Nominal Frequency	F _{NOM}	8.000		150.000	MHz	
Mode	em	Fundan				
Operating Temperature Range	T _{OP}	0/70, -	°C			
Stability Over T _{OP} ¹	F _{STAB}	±10		±100	ppm	
Frequency Tolerance ²	F _{TOL}		±10		ppm	
Load Capacitance	C _L	6		32	pF	
Shunt Capacitance	C _o			5	pF	
Drive Level			10	100	uW	
Aging / 1st year (at 25 °C)	F _{AGE}			±5	ppm	
Insulation Resistance		500			MOhm	
Storage Temperature	T _{sto}	-40		90	°C	
	Equivalent Se	eries Resistance				
Crystal Frequency 8.000MHz-12.000MHz 12.001MHz-16.000MHz 16.001MHz-20.000MHz 20.001MHz-24.000MHz 24.001MHz-54.000MHz 40.000MHz-150.000MHz, 3rd Overtone	ESR			80 60 50 40 30 80	Ohm	

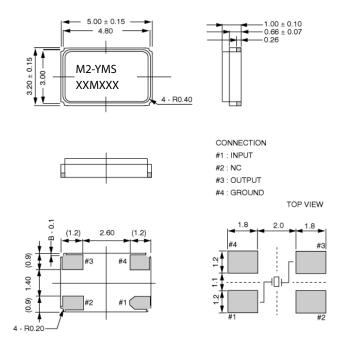
Notes:

- 1. Referenced to the Frequency at 25 °C.
- 2. Frequency measured at 25 °C \pm 3 °C.

Product is compliant to RoHS directive and fully compatible with lead free assembly.



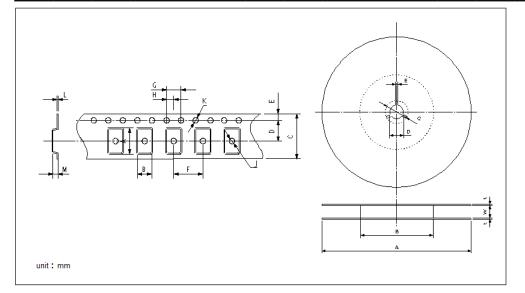
Package Drawing



Marking M2 = VXM2Y = YearM=Month A=January L = December S= Manufacturing location XXMXXX = Frequency

Tape & Reel

Table	Table 7. Tape and Reel Dimensions (mm)																	
Таре												Reel						
Α	В	C	D	Е	F	G	Н	J	K	L	М	Α	В	С	D	Е	W	Т
5.25	3.45	12.0	5.5	1.75	8.0	4.0	2.0	1.5	1.5	0.3	1.1	178	180	21.0	13.0	2.0	12.4	2.0



1K pieces per reel

Reliability & IR Compliance

Solderprofile:

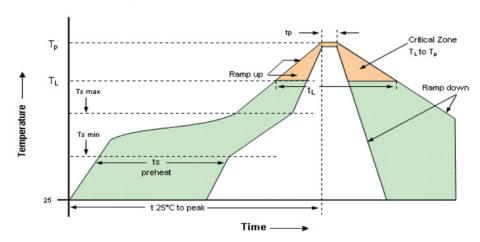
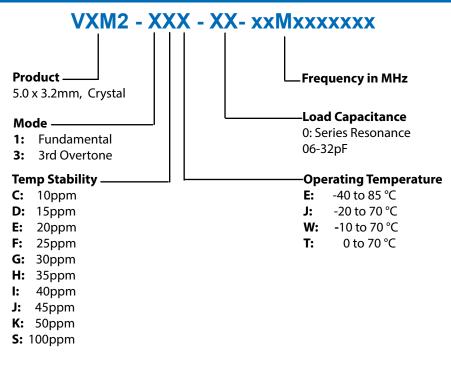


Table 2: Reflow Profile						
Parameter	Symbol	Value				
PreHeat Time Ts-min Ts-max	t _s	60 sec Min, 260 sec Max 150°C 200°C				
Ramp Up	R _{UP}	3 °C/sec Max				
Time Above 217 °C	t _L	60 sec Min, 150 sec Max				
Time To Peak Temperature	T _{AMB-P}	480 sec Max				
Time at 260 °C	t _p	30 sec Max				
Ramp Down	R _{DN}	6 °C/sec Max				

Pads are Au over Ni and compatible with either SnPb or Pb free attachment. MSL: 1

Ordering Information



*Note: not all combination of options are available. Other specifications may be available upon request.

10ppm stability not available for -40 to 85°C

* Add _SNPBDIP for tin lead solder dip Example: VXM2-1KE-18-10M0000000 SNPBDIP

Revision History

Revision Date	Approved	Description			
August 29, 2016	RC	Initial datasheet for factory approval and release to customer.			
September 17, 2018	FB	Update loo and contact information, add 1K pieces per reel and "SNPBDIP" ordering option			



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